LOW-VOLTAGE 24-BIT BUS EXCHANGE SWITCH

74CBTLV16212

FEATURES:

- 5Ω A/B bi-directional switch
- Isolation Under Power-Off Conditions
- · Over-voltage tolerant
- · Latch-up performance exceeds 100mA
- Vcc = 2.3V 3.6V, normal range
- ESD >2000V per MIL-STD-883, Method 3015; >200V using machine model (C = 200pF, R = 0)
- · Available in TSSOP package

DESCRIPTION:

The CBTLV16212 provides a set of 24 high-speed switches for bus exchanging and switching. The device has low ON resistance, resulting in under 250ps propagation delay through the switch. The CBTLV16212 operates as a single 24-bit bus switch or as a 12-bit bus exchanger, which provides data exchanging between the four signal ports through the data select (So-S2) pins.

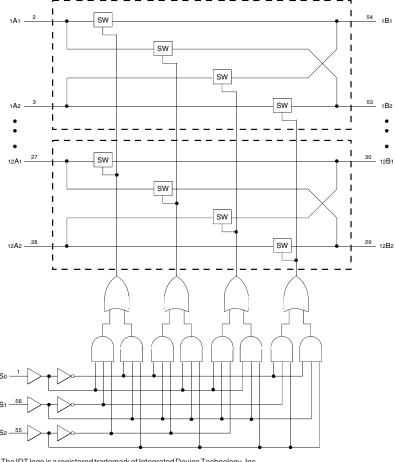
The CBTLV16212 has the break-before-make feature, which allows zero current when switching between ports B1 and B2.

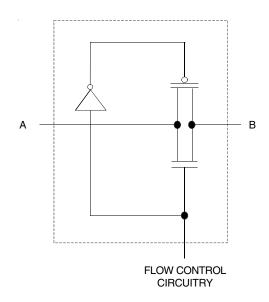
APPLICATIONS:

· 3.3V High Speed Bus Switching and Bus Isolation

FUNCTIONAL BLOCK DIAGRAM

SIMPLIFIED SCHEMATIC, EACH **SWITCH**





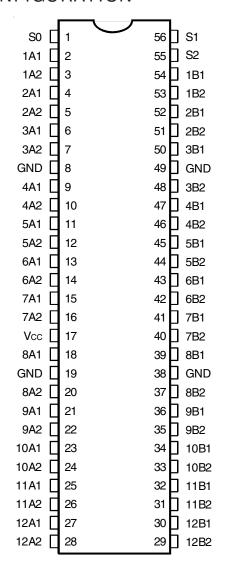
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INDUSTRIAL TEMPERATURE RANGE

JUNE 2019



PIN CONFIGURATION



TOP VIEW

Package Type	Package Code	Order Code
TSSOP	PAG56	PAG

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max.	Unit
Vcc	Supply Voltage Range	-0.5 to 4.6	V
Vı	Input Voltage Range	-0.5 to 4.6	V
	Continuous Channel Current	128	mA
lık	Input Clamp Current, VI/O < 0	– 50	mA
Tstg	Storage Temperature Range	-65 to +150	°C

NOTE:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

PIN DESCRIPTION

Pin Names	Description	
Sx	Data Select	
xAx	Port A Inputs or Outputs	
xBx	Port B Inputs or Outputs	

FUNCTION TABLE(1)

	Inputs		Inputs/Outputs		
S2	S1	S ₀	A1	A2	Operation
L	L	L	Z	Z	Disconnect
L	L	Н	B1	Z	A1 port = B1 port
L	Н	L	B2	Z	A1 port = B2 port
L	Н	Н	Z	B1	A2 port = B1 port
Н	L	L	Z	B2	A2 port = B2 port
Н	L	Н	Z	Z	Disconnect
Н	Н	L	B1	B2	A1 port = B1 port
					A2 port = B2 port
Н	Н	Н	B2	B1	A1 port = B2 port
					A2 port = B1 port

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

Z = High-Impedance

OPERATING CHARACTERISTICS(1)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
Vcc	Supply Voltage		2.3	3.6	V
ViH	High-Level Control Input Voltage	Vcc = 2.3V to 2.7V	1.7	_	V
		Vcc = 2.7V to 3.6V	2	_	
VIL	Low-Level Control Input Voltage	Vcc = 2.3V to 2.7V	_	0.7	V
		Vcc = 2.7V to 3.6V	_	0.8	
TA	Operating Free-Air Temperature		-40	+85	°C

NOTE:

1. All unused control inputs of the device must be held at Vcc or GND to ensure proper device operation.



74CBTLV16212 LOW-VOLTAGE 24-BIT BUS EXCHANGESWITCH

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: $TA = -40^{\circ}C$ to $+85^{\circ}C$

Symbol	Parameter	Test Conditions	Min.	Тур. ⁽¹⁾	Max.	Unit	
VIK	Control Inputs, Data I/O	Vcc = 3V, Iı = −18mA	Vcc = 3V, II = -18mA			-1.2	٧
lı	Control Inputs	Vcc = 3.6V, Vi = Vcc or GNE)	_	_	±1	μΑ
loz	Data I/O	Vcc = 3.6V, Vo = 0V or 3.6V	switch disabled	_	_	5	μА
loff		Vcc = 0V, Vi or Vo = 0V or 3	.6V	_	_	10	μА
Icc		Vcc = 3.6V, Io = 0, VI = Vcc or GND		_	_	10	μА
$\Delta \text{Icc}^{(2)}$	Control Inputs	Vcc = 3.6V, one input at 3V, other inputs at Vcc or GND		_	_	300	μА
Сі	Control Inputs	VI = 3V or 0		_	5	_	рF
CIO(OFF)		Vo = 3V or 0 (switch off)		_	13.5	_	pF
	Max. at Vcc = 2.3V	VI = 0	Io = 64mA	_	5	8	
	Typ. at Vcc = 2.5V		Io = 24mA	_	5	8]
Ron ⁽³⁾		VI = 1.7V	Io = 15mA	_	27	40	Ω
		VI = 0	Io = 64mA	_	5	7	
	Vcc = 3V		Io = 24mA	_	5	7	
		VI = 2.4V	Io = 15mA	_	10	15	

NOTES:

- 1. Typical values are at 3.3V, +25°C ambient.
- 2. The increase in supply current is attributable to each input that is at the specified voltage level rather than Vcc or GND.
- 3. This is measured by the voltage drop between the A and B terminals at the indicated current through the switch.

SWITCHING CHARACTERISTICS

		$Vcc = 2.5V \pm 0.2V$		$Vcc = 3.3V \pm 0.3V$		
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
tPD ⁽¹⁾	Propagation Delay	_	0.15	_	0.25	ns
	A to B or B to A					
tPD	Propagation Delay	3	11.1	3	8.8	ns
	S to A or B					
ten	Output Enable Time	3	10.9	3	8.6	ns
	S to A or B					
tois	Output DisableTime	1	8.7	2	8.8	ns
	S to A or B					

NOTE:

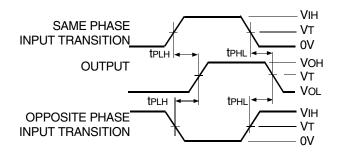
1. The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance when driven by an ideal voltage source (zero output impededance).



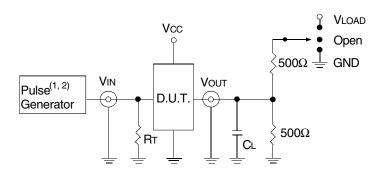
TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	Vcc ⁽¹⁾ =3.3V±0.3V	Vcc ⁽²⁾ =2.5V±0.2V	Unit
VLOAD	6	2 x Vcc	٧
VIH	3	Vcc	٧
VT	1.5	Vcc / 2	٧
VLZ	300	150	mV
VHZ	300	150	mV
CL	50	30	рF



Propagation Delay



Test Circuits for All Outputs

DEFINITIONS:

 $\mathsf{CL} = \mathsf{Load}$ capacitance: includes jig and probe capacitance.

 $\mbox{\it RT}$ = Termination resistance: should be equal to $\mbox{\it ZOUT}$ of the Pulse Generator.

NOTES:

- 1. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2.5ns; tR \leq 2.5ns.
- 2. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2ns; tR \leq 2ns.

ENABLE DISABLE V_{IH} CONTROL Vт **INPUT** 0V tpzl tPLZ ◀ VLOAD/2 OUTPUT VLOAD/2 SWITCH) **NORMALLY** Vol + Vlz CLOSED LOW Vol tphz -OUTPUT Vон **SWITCH** Von -Vhz **NORMALLY OPEN** ٥V HIGH 0V

NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Enable and Disable Times

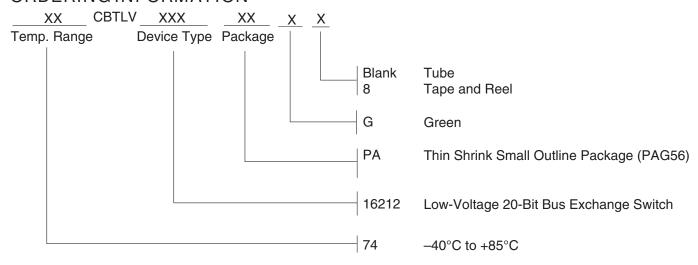
SWITCH POSITION

Test	Switch
tplz/tpzL	Vload
tpHz/tpzH	GND
tro	Open



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ORDERING INFORMATION



Orderable Part Information

Speed (ns)	Orderable Part ID	Pkg. Code	Pkg. Type	Temp. Grade
	74CBTLV16212PAG	PAG56	TSSOP	I
	74CBTLV16212PAG8	PAG56	TSSOP	I

Datasheet Document History

 $12/04/2014 \qquad \qquad \text{Pg.} \quad 5 \qquad \quad \text{Updated the ordering information by removing the "IDT" notation, non RoHS part and by adding Tape and Reel information.}$

 $06/03/2019 \hspace{1cm} \textbf{Pg.} \hspace{0.2cm} 2,5 \hspace{0.2cm} \textbf{Added table under pin configuration diagram with detailed package information and orderable part information} \\$

table. Updated the ordering information diagram in clearer detail.

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